

Description

The SX40P10D uses advanced trench technology to provide excellent $R_{DS(ON)}$, low gate charge and operation with gate voltages as low as 4.5V. This device is suitable for use as a Battery protection or in other Switching application.

General Features

$V_{DS} = -100V$ $I_D = -40A$

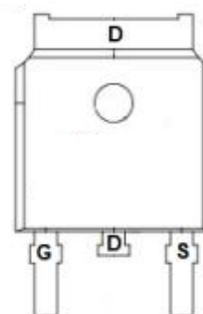
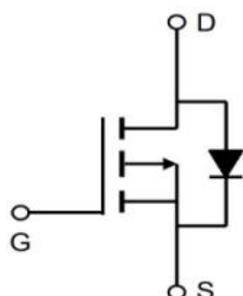
$R_{DS(ON)} < 50m\Omega @ V_{GS} = 10V$

Application

Brushless motor

Load switch

Uninterruptible power supply



Absolute Maximum Ratings ($T_C = 25^\circ C$ unless otherwise noted)

Symbol	Parameter	Rating	Units
V _{DS}	Drain-Source Voltage	-100	V
V _{GS}	Gate-Source Voltage	±20	V
$I_D @ T_C = 25^\circ C$	Continuous Drain Current, $V_{GS} @ -10V^1$	-40	A
$I_D @ T_C = 100^\circ C$	Continuous Drain Current, $V_{GS} @ -10V^1$	-29	A
IDM	Pulsed Drain Current ²	-120	A
EAS	Single Pulse Avalanche Energy ³	560	mJ
IAS	Avalanche Current	-29	A
$P_D @ T_C = 25^\circ C$	Total Power Dissipation ⁴	104	W
TSTG	Storage Temperature Range	-55 to 150	°C
T _J	Operating Junction Temperature Range	-55 to 150	°C
R _{θJA}	Thermal Resistance Junction-Ambient ¹	62.5	°C/W
R _{θJC}	Thermal Resistance Junction-Case ¹	1.22	°C/W

P-Channel Electrical Characteristics (T_J =25 °C, unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
BVDSS	Drain-Source Breakdown Voltage	V _{GS} =0V , I _D =-250uA	-100	-110	---	V
RDS(ON)	Static Drain-Source On-Resistance ²	V _{GS} =-10V , I _D =-10A	---	38	50	mΩ
		V _{GS} =-4.5V , I _D =-8A	---	40	52	
VGS(th)	Gate Threshold Voltage	V _{GS} =V _{DS} , I _D =-250uA	-1.2	-1.8	-2.5	V
IDSS	Drain-Source Leakage Current	V _{DS} =-100V , V _{GS} =0V , T _J =25°C	---	---	-1	uA
IGSS	Gate-Source Leakage Current	V _{GS} =±20V , V _{DS} =0V	---	---	±100	nA
gfs	Forward Transconductance	V _{DS} =-10V , I _D =-10A	---	32	---	S
Q _g	Total Gate Charge	V _{DS} =-80V V _{GS} =-10V I _D =-14A	---	92	---	nC
Q _{gs}	Gate-Source Charge		---	17.5	---	
Q _{gd}	Gate-Drain Charge		---	14	---	
Td(on)	Turn-On Delay Time	V _{DD} =-50V , V _{GS} =-10V ,R _G =3.3Ω,I _D =-14A	---	20.5	---	ns
T _r	Rise Time		---	32.2	---	
Td(off)	Turn-Off Delay Time		---	123	---	
T _f	Fall Time		---	63.7	---	
Ciss	Input Capacitance	V _{DS} =-25V, V _{GS} =0V, f=1MHz	---	6516	---	pF
Coss	Output Capacitance		---	223	---	
Crss	Reverse Transfer Capacitance		---	125	---	
IS	Continuous Source Current ^{1,5}	V _G =V _D =0V , Force Current	---	---	-40	A
VSD	Diode Forward Voltage ²	V _{GS} =0V , I _S =-1A , T _J =25°C	---	---	-1.2	V
trr	Reverse Recovery Time	I _F =-14A , di/dt=-100A/μs , T _J =25°C	---	31.2	---	nS
Q _{rr}	Reverse Recovery Charge		---	31.97	---	nC

Note :

- 1、 The data tested by surface mounted on a 1 inch 2 FR-4 board with 2OZ copper.
- 2、 The data tested by pulsed , pulse width ≅ 300us , duty cycle ≅ 2%
- 3、 The EAS data shows Max. rating . The test condition is V DD =-25V,V GS =-10V,L=0.1mH,IAS =-29A
- 4、 The power dissipation is limited by 150°Cjunction temperature
- 5、 The data is theoretically the same as I D and I DM , in real applications , should be limited by total power dissipation.

Typical Characteristics

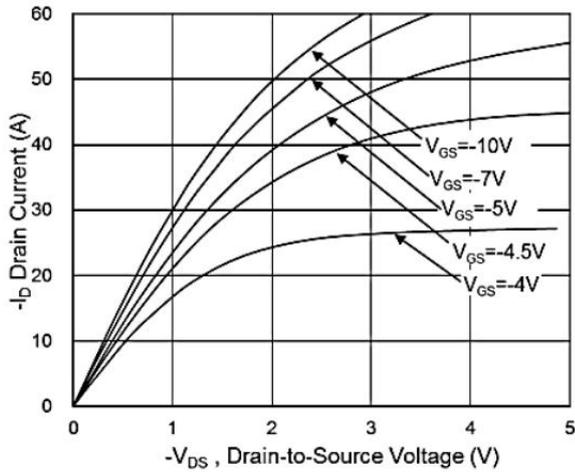


Fig.1 Typical Output Characteristics

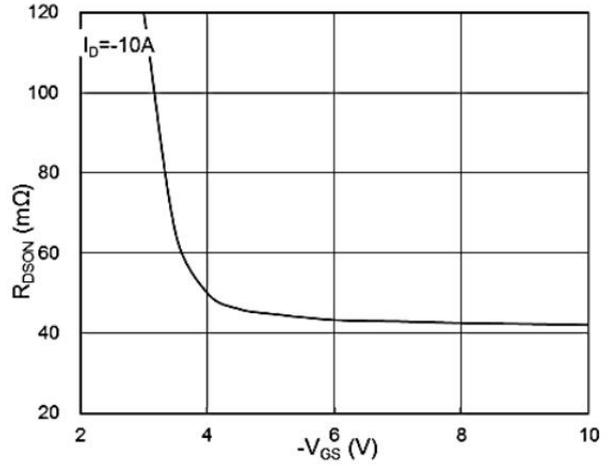


Fig.2 On-Resistance vs G-S Voltage

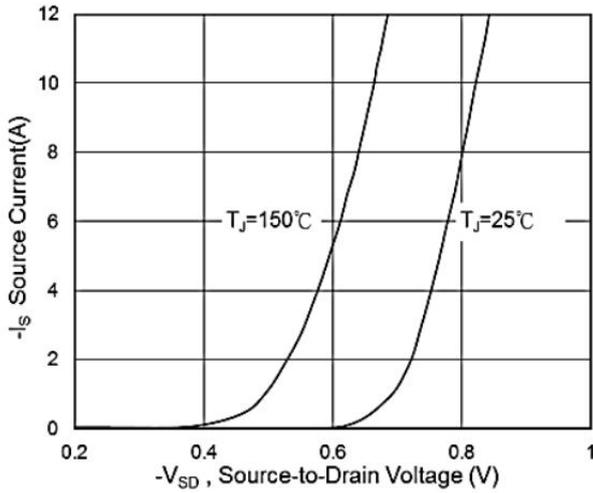


Fig.3 Typical S-D Diode Forward Voltage

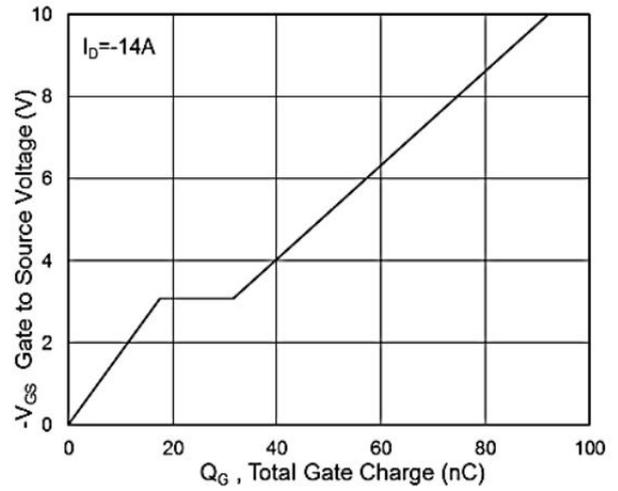


Fig.4 Gate-Charge Characteristics

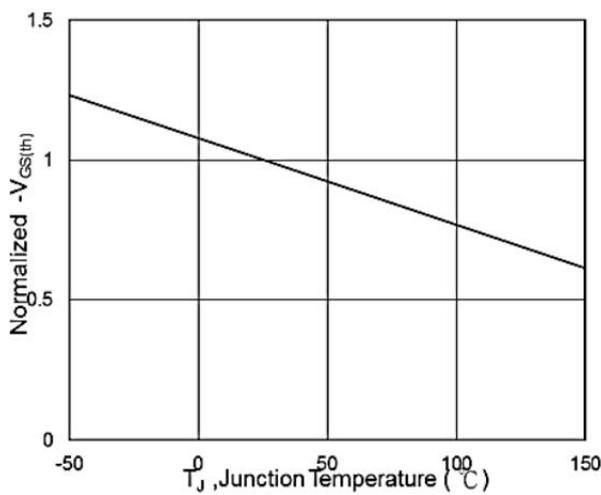


Fig.5 Normalized $V_{GS(th)}$ vs T_J

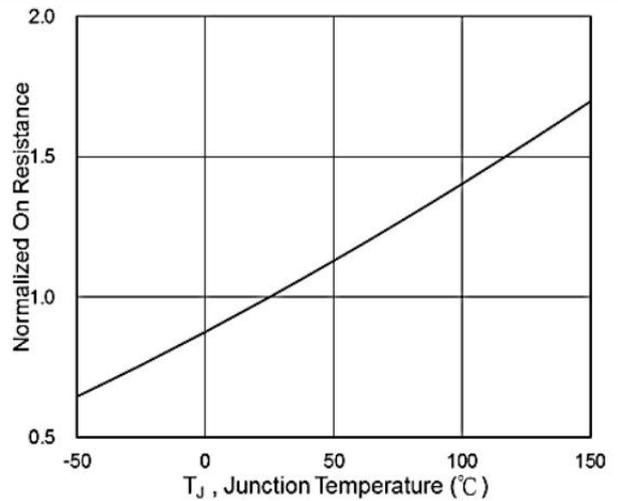


Fig.6 Normalized $R_{DS(on)}$ vs T_J

Typical Characteristics

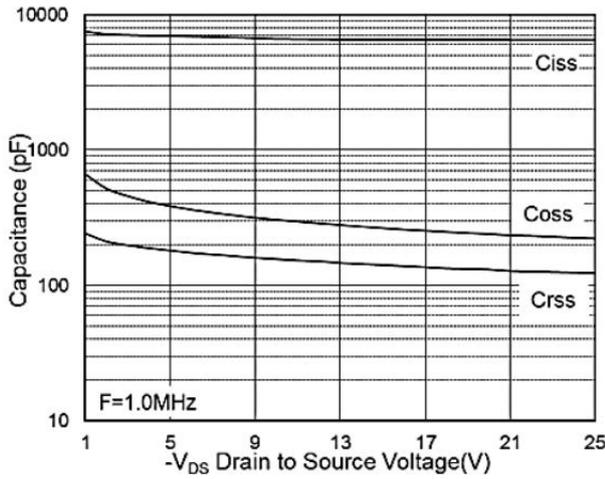


Fig.7 Capacitance

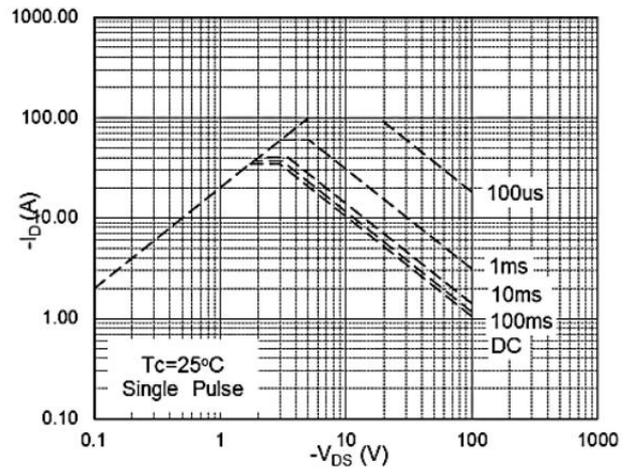


Fig.8 Safe Operating Area

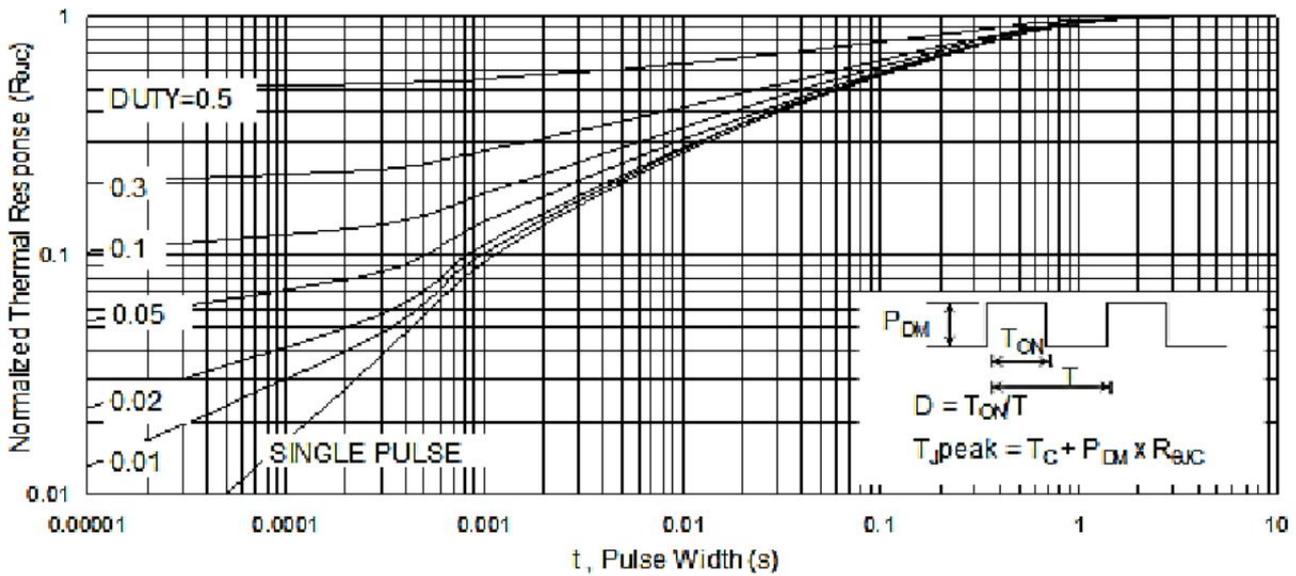


Fig.9 Normalized Maximum Transient Thermal Impedance

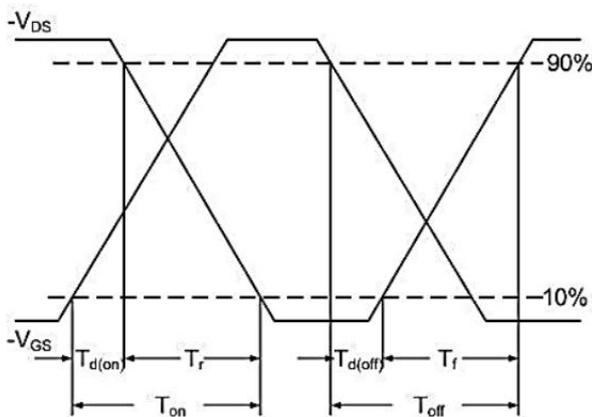


Fig.10 Switching Time Waveform

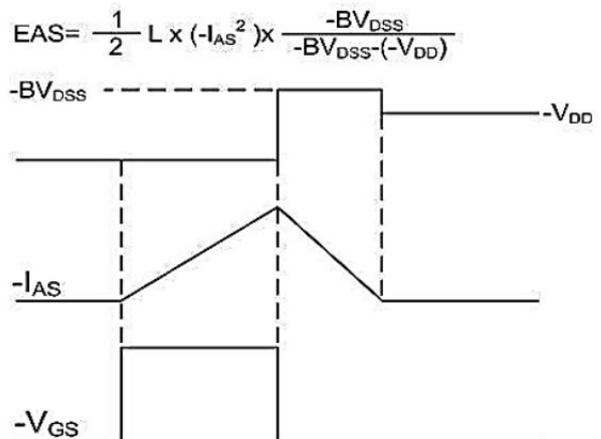
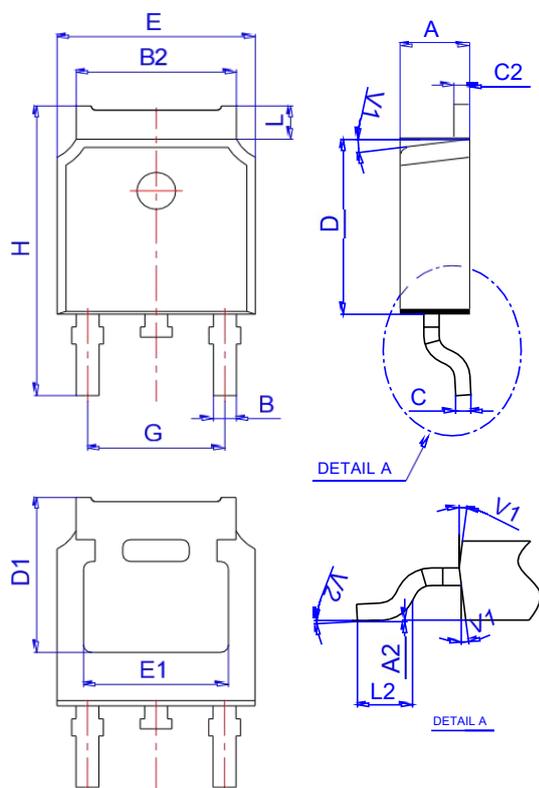


Fig.11 Unclamped Inductive Waveform

$$EAS = \frac{1}{2} L \times (-I_{AS}^2) \times \frac{-BV_{DSS}}{-BV_{DSS} - (-V_{DD})}$$

Package Mechanical Data:TO-252-3L



Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	2.10		2.50	0.083		0.098
A2	0		0.10	0		0.004
B	0.66		0.86	0.026		0.034
B2	5.18		5.48	0.202		0.216
C	0.40		0.60	0.016		0.024
C2	0.44		0.58	0.017		0.023
D	5.90		6.30	0.232		0.248
D1	5.30REF			0.209REF		
E	6.40		6.80	0.252		0.268
E1	4.63			0.182		
G	4.47		4.67	0.176		0.184
H	9.50		10.70	0.374		0.421
L	1.09		1.21	0.043		0.048
L2	1.35		1.65	0.053		0.065
V1		7°			7°	
V2	0°		6°	0°		6°

Package Marking and Ordering Information

Product ID	Pack	Marking	Qty(PCS)
TAPING	TO-252-3L		2500